

NCEP0160F

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP0160F uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

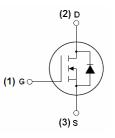
- V_{DS} =100V, I_D =60A $R_{DS(ON)}$ =9.2m Ω (typical) @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-220F top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP0160F	NCEP0160F	TO-220F	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	60	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	42.4	Α
Pulsed Drain Current	I _{DM}	240	Α
Maximum Power Dissipation	P _D	35	W
Derating factor		0.23	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	290	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 175	$^{\circ}$

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	R _{θJC}	4.3	°C/W
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Electrical Characteristics (T_C=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =30A	-	9.2	10.8	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =30A	-	40	-	S
Dynamic Characteristics (Note4)	1		•	l .		
Input Capacitance	C _{lss}		-	2500	-	PF
Output Capacitance	C _{oss}	$V_{DS}=50V, V_{GS}=0V,$	-	273	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	27	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	13	-	nS
Turn-on Rise Time	t _r	V_{DD} =50V, I_D =30A	-	8.5	-	nS
Turn-Off Delay Time	$t_{\sf d(off)}$	V_{GS} =10 V , R_{G} =4.7 Ω	-	29	-	nS
Turn-Off Fall Time	t _f		-	4	-	nS
Total Gate Charge	Qg	\/ 50\/ L 00A	-	37		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=50V, I_{D}=30A,$	-	14		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	8		nC
Drain-Source Diode Characteristics	1		•	Į.		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =60A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	60	Α
Reverse Recovery Time	t _{rr}	$T_J = 25$ °C, $I_F = I_S$	-	58		nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	149		nC

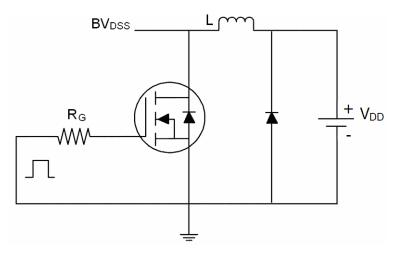
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\!\!\mathrm{C}$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25 Ω

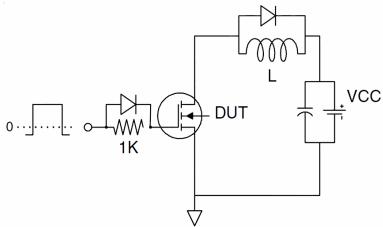


Test Circuit

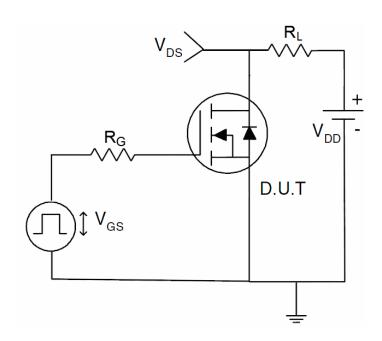
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics

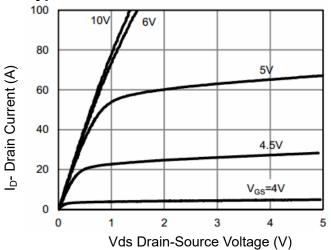


Figure 1 Output Characteristics

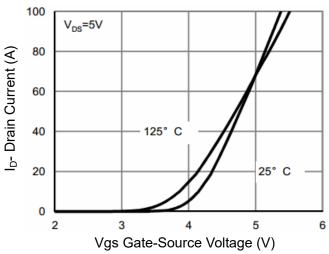


Figure 2 Transfer Characteristics

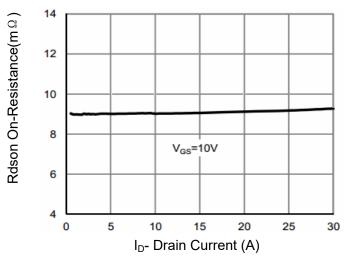


Figure 3 Rdson- Drain Current

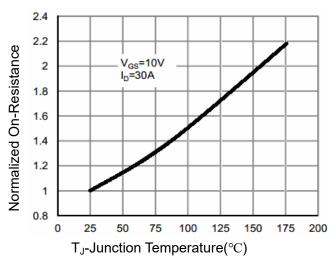


Figure 4 Rdson-JunctionTemperature

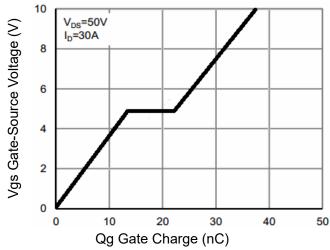


Figure 5 Gate Charge

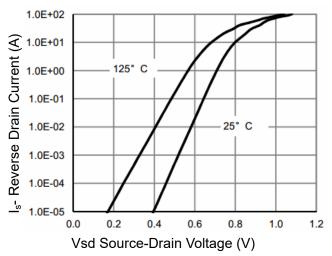


Figure 6 Source- Drain Diode Forward



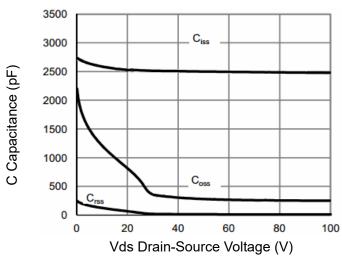


Figure 7 Capacitance vs Vds

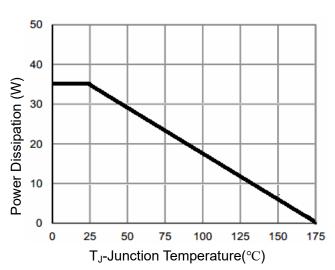


Figure 9 Power De-rating

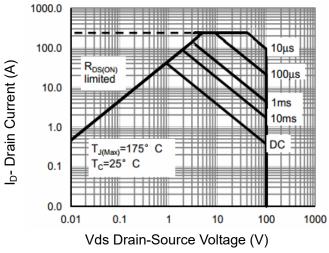


Figure 8 Safe Operation Area

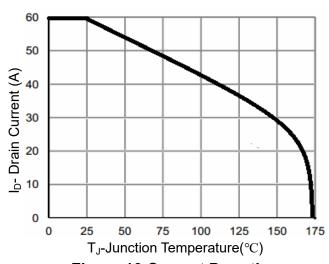


Figure 10 Current De-rating

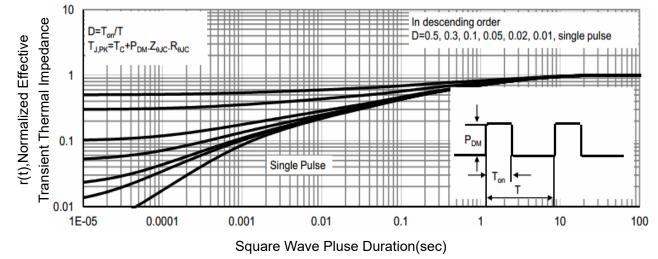
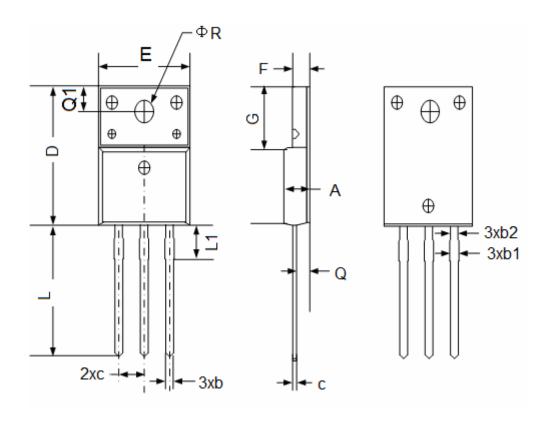


Figure 11 Normalized Maximum Transient Thermal Impedance



TO-220F Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.50	4.83	0.18	0.19	
b	0.70	0.91	0.03	0.04	
b1	1.20	1.47	0.05	0.06	
b2	1.10	1.38	0.04	0.05	
С	0.45	0.63	0.02	0.02	
D	15.67	16.07	0.62	0.63	
е	2.54 BSC		0.10 BSC		
E	9.96	10.36	0.39	0.41	
F	2.34	2.74	0.09	0.11	
G	6.48	6.90	0. 26	0. 27	
L	12.68	13.30	0.50	0.52	
L1	3.13	3.50	0.12	0.14	
Q	2.56	2.93	0.10	0.12	
Q1	3.20	3.40	0.13	0.13	
ΦR	3.08	3.28	0.12	0.13	



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